

Report Title: Report Number:	ADL8142 MSL-1 Product Qualification 19790			
<b>Revision:</b>	Α			
Date:	16 August 2022			



#### Summary

This report documents the successful completion of the reliability qualification requirements for the release of the ADL8142 product in an 8-LFCSP package. The ADL8142 is a gallium arsenide (GaAs), monolithic microwave integrated circuit (MMIC), pseudomorphic high electron mobility transistor (pHEMT), low noise wideband amplifier that operates from 23 GHz to 31 GHz.

# Table 1: ADL8142 Product Characteristics

#### Die/Fab

Die Id	FP968 A
Die Size (mm)	0.94 x 1.02
Wafer Fabrication Process	GaAs
Passivation Layer	SiN
Bond Pad Metal Composition	Au

#### Package/Assembly

Package	8-LFCSP
Body Size (mm)	2.00 x 2.00 x 0.85
Assembly Location	ASE
Molding Compound	Sumitomo G700LYT
Lead Frame Material	Copper
Moisture Sensitivity Level	1
Maximum Peak Reflow Temperature (°C)	260



### **Description / Results of Tests Performed**

Table 2 & 3 provide a description of the qualification tests conducted and the associated test results for products manufactured on the same technologies as described in Table 1. All devices were electrically tested before and after each stress. Any device that did not meet all electrical data sheet limits following stressing would be considered a valid (stress-attributable) failure unless there was conclusive evidence to indicate otherwise.

Test Name	Specification	Conditions	Device	Lot #	Sample Size	Qty. Failures
Lligh Torgan anothing Otorgan		45000 4 000	HMC8411LP2FE	Q14156.HS1	77	0
High Temperature Storage	JESD22-A103	150°C, 1,000	HMC8412LP2FE	Q14487.HS1	77	0
Life (HTSL)		Hours	HMC8413LP2FE	Q14497.HS1	77	0
Solder Heat Resistance (SHR) <sup>1</sup>	J-STD-020	MSL-1	ADL8142	Q19790.1.SH1	30	0
		-65°C/+150°C,	HMC8411LP2FE	Q14156.TC2	77	0
				Q14156.TC3	77	0
				Q15087.TC1	77	0
		1,000 Cycles	HMC8412LP2FE	Q15087.TC2	1     77       1     77       1     77       1     77       11     30       2     77       3     77       1     77       2     77       4     77       1     77       2     77       3     77       4     77       1     77       2     77       3     77	0
Temperature Cycling (TC) <sup>1</sup>	JESD22-A104			Q15087.TC4		0
				Q11648.TC1	77	0
		-65°C/+150°C, 500 Cycles	ADP7183	Q11648.TC2	77	0
				Q11648.TC3	77	0
			ADL8142	Q19790.1.TC1	77	0

## Table 2: LFCSP Package Qualification Test Results

<sup>1</sup> These samples were subjected to preconditioning (per J-STD-020 Level 1) prior to the start of the stress test. Level 1 preconditioning consists of the following: Bake: 24 hrs @ 125°C, Unbiased Soak: 168 hrs @ 85°C, 85%RH, Reflow: 3 passes through an oven with a peak temperature of 260°C.



Test Name	Specification	Conditions	Device	Lot #	Sample Size	Qty. Failures	
				Q13161.HO1	77	0	
			ADL9005-	Device         Lot #         Size           ADL9005 <sup>2</sup> Q13161.HO1         77           Q13161.HO2         77           Q13161.HO2         77           Q14156.HO1         77           Q14156.HO2         77           Q14156.HO3         77           Q14156.HO3         77           Q14156.HO3         77           C8412LP2FE <sup>1</sup> Q14487.HO1         77           C8413LP2FE <sup>1</sup> Q14497.HO5         77           ADL8104 <sup>2</sup> Q16788.H01         77           ADL9005         Q13161.HS2         77           C8411LP2FE         Q14156.HS1         77           Q16788.H03         77         77           Q14156.HS1         77         77	77	0	
				Q14156.HO1	77	0	
1 JESD22-	150°C <tj<175°c,< td=""><td>HMC8411LP2FE<sup>1</sup></td><td>Q14156.HO2</td><td>77</td><td>0</td></tj<175°c,<>	HMC8411LP2FE <sup>1</sup>	Q14156.HO2	77	0		
		Biased, 1,000		Q14156.HO3	77	0	
	Hours	HMC8412LP2FE <sup>1</sup>	Q14487.HO1	77	0		
		HMC84		HMC8413LP2FE <sup>1</sup>	Q14497.HO5	Size         Failu           77         0	0
				Lot #         Size         Fail           Q13161.HO1         77         0           Q13161.HO2         77         0           Q13161.HO2         77         0           Q14156.HO1         77         0           Q14156.HO2         77         0           Q14156.HO3         77         0           Q14487.HO1         77         0           Q14487.HO3         77         0           Q16788.H01         77         0           Q13161.HS2         77         0           Q14156.HS1         77         0	0		
			ADL8104-	Q16788.H03	77	0	
Storage Life		2- 150°C, 1,000 HMC8411LP2FE Q14156.HS1 7 Hours HMC8412LP2FE Q14487.HS1 7	ADL9005	Q13161.HS2	77	0	
	JESD22-		HMC8411LP2FE	Q14156.HS1	77	0	
	A103		HMC8412LP2FE	Q14487.HS1	77	0	
(HTSL)			77	0			

## Table 3: GaAs pHEMT Qualification Test Results

<sup>1</sup> These samples were subjected to preconditioning (per J-STD-020 Level 1) prior to the start of the stress test. Level 1 preconditioning consists of the following: Bake: 24 hrs @ 125°C, Unbiased Soak: 168 hrs @ 85°C, 85%RH, Reflow: 3 passes through an oven with a peak temperature of 260°C.

<sup>2</sup> These samples were subjected to preconditioning (per J-STD-020 Level 3) prior to the start of the stress test. Level 3 preconditioning consists of the following: Bake: 24 hrs @ 125°C, Unbiased Soak: 192 hrs @ 30°C, 60%RH, Reflow: 3 passes through an oven with a peak temperature of 260°C.

Samples of the many devices manufactured with these package and process technologies are continuously undergoing reliability evaluation as part of the ADI Reliability Monitor Program. Additional qualification data is available on <u>Analog Devices' web site</u>.



### **ESD Test Results**

The results of Field-Induced Charged Device Model (FICDM) ESD testing is summarized in Table 3. ADI measures ESD results using stringent test procedures based on the specifications listed. Any comparison with another supplier's results should ensure that the same ESD test procedures have been used. For further details, please see the EOS/ESD chapter of the ADI Reliability Handbook (available via the 'Quality and Reliability' link on <u>Analog Devices' web site</u>).

ESD Model	Package	ESD Test Spec	RC Network	Highest Pass Level	First Fail Level	Class
FICDM	8-LFCSP	JS-002	1Ω, Cpkg	±750V	±1000V	C2B
НВМ	8-LFCSP	ESDA/JEDEC JS-001- 2011	1.5kΩ, 100pF	±400V	±500V	1A

#### Table 4: ADL8142 ESD Test Results

## Approvals

Reliability Engineer: Carl Bunis

## Additional Information

Data sheets and other additional information are available on Analog Devices' web site